

Refine Search

Search Results -

Terms	Documents
(under adj bump adj metalization) and (copper same nickel same titanium same wetting)	0

Database:

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 US Patents Full-Text Database
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result set

<i>DB=JPAB; PLUR=YES; OP=ADJ</i>			
<u>L6</u> (under adj bump adj metalization) and (copper same nickel same titanium same wetting)	0	<u>L6</u>	
<i>DB=EPAB; PLUR=YES; OP=ADJ</i>			
<u>L5</u> (under adj bump adj metalization) and (copper same nickel same titanium same wetting)	0	<u>L5</u>	
<i>DB=PGPB; PLUR=YES; OP=ADJ</i>			
<u>L4</u> (under adj bump adj metalization) and (copper same nickel same titanium same wetting)	9	<u>L4</u>	
<i>DB=TDBD; PLUR=YES; OP=ADJ</i>			
<u>L3</u> (under adj bump adj metalization) and (copper same nickel same titanium same wetting)	0	<u>L3</u>	
<i>DB=DWPI; PLUR=YES; OP=ADJ</i>			
<u>L2</u> (under adj bump adj metalization) and (copper same nickel same titanium same wetting)	0	<u>L2</u>	
<i>DB=USPT; PLUR=YES; OP=ADJ</i>			
<u>L1</u> (under adj bump adj metalization) and (copper same nickel same titanium same wetting)	5	<u>L1</u>	

END OF SEARCH HISTORY